



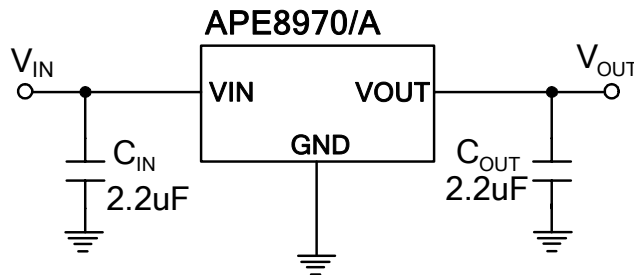
FEATURES

- Input Voltage Range : 2.6V~5.5V
- Dropout Voltage is 380mV at 1A Output Current
- Guaranteed 1.2A Output Current
- Low Quiescent Current is 50µA (typ.)
- Fixed Output Voltage is form 1.2 V to 5V by 0.1V Steps.
- Fast Transient Response
- Current Limit and Thermal Shutdown Protection
- Short Circuit Current Fold-back
- Available in the 3-Pin Pb-Free SOT-223, TO-263 and TO-252 Packages

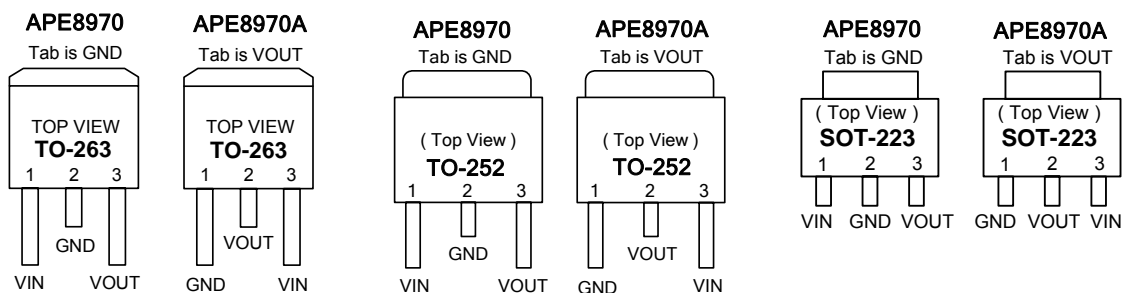
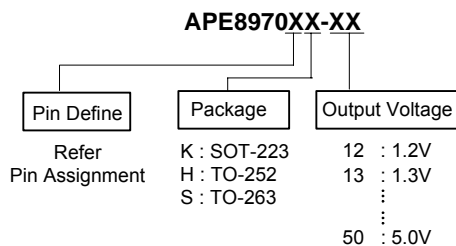
DESCRIPTION

The APE8970/A is a low noise, high output current, low quiescent current and low dropout linear regulator. The Device includes pass element, error amplifier, band-gap, current-limit and thermal shutdown circuitry. The output current is up to 1.2A. The characteristics of low dropout voltage and less quiescent current make it good for some critical current application, for example, some battery powered devices. The typical quiescent current is approximately 50µA. Due to internal flexible design, result in extensively fixed output voltage versions form 1.2V to 5V per 0.1V steps. Built-in current-limit, Short current protection and thermal-shutdown functions prevent any fault condition from IC damage.

TYPICAL APPLICATION



ORDERING/PACKAGE INFORMATION





ABSOLUTE MAXIMUM RATINGS (at $T_A=25^\circ\text{C}$)

VIN Pin Voltage(V_{IN})	-----	GND - 0.3V to GND + 6V
Output Voltage(V_{OUT})	-----	GND - 0.3V to VIN + 0.3V
Power Dissipation(P_D)	SOT-223	1.3W
	TO-252	2.2W
	TO-263	4W
Storage Temperature Range(T_{ST})	-----	-40°C to +150°C
Junction Temperature Range(T_J)	-----	-40°C To 125°C
Operating Temperature Range (T_{OP})	-----	-40°C to +85°C
Thermal Resistance from Junction to Case($R_{th_{JC}}$)		
	SOT-223	15°C/W
	TO-252	10°C/W
	TO-263	3.5°C/W
Thermal Resistance from Junction to Ambient($R_{th_{JA}}$)		
	SOT-223	75°C/W
	TO-252	45°C/W
	TO-263	25°C/W

Note: $R_{th_{JA}}$ is measured with the PCB copper area of approximately 1 in2(Multi-layer). That need connect to tap pin.

ELECTRICAL SPECIFICATIONS

($T_A=25^\circ\text{C}$ unless otherwise specified)

Parameter	SYM	TEST CONDITION	MIN	TYP	MAX	UNITS	
Input Voltage	V_{IN}	(Note1)	2.6	-	5.5	V	
Output Voltage Accuracy (Note1)	ΔV_{OUT}	$V_{IN}=V_{OUT}+0.1V$ to 6V $V_{OUT} \geq 2.5V, I_{OUT}=1mA$	-2	-	2	%	
		$V_{IN}=2.6V$ to 6V $2.5V > V_{OUT} \geq 1.2V, I_{OUT}=1mA$	-3	-	3		
Quiescent Current	I_Q	$I_{OUT}=0mA, V_{IN}=5V$	-	50	-	μA	
Dropout Voltage	V_{DROP}	$I_{OUT}=1.0A$	$V_{OUT}=1.2V$	-	1.3	1.5	V
			$V_{OUT}=1.5V$	-	1.1	1.4	
			$V_{OUT}=1.8V$	-	0.8	1.1	
			$V_{OUT}=2.5V$	-	0.57	0.7	
			$V_{OUT}=3.3V$	-	0.38	0.6	
Current Limit (Note 2)	I_{LIMIT}		1.3	1.5	-	A	
Short Circuit Current	I_{short}	Output Voltage < 0.375 x VOUT	-	600	-	mA	
Load Regulation (Note 3)	ΔV_{LOAD}	$I_{OUT}=10m \sim 1.2A$	$2.0V > V_{OUT}$	-	10	20	mV
			$2.0V \leq V_{OUT}$	-	0.5	1	%
Ripple Rejection	PSRR	$C_{IN}=2.2\mu F, C_O=2.2\mu F,$ $I_{OUT}=10mA$	F=120Hz	-	65	-	dB
			F=1KHz	-	55	-	
Temperature Shutdown	TS		-	140	-	$^\circ\text{C}$	
Temperature Shutdown Hysteresis	TSH		-	30	-	$^\circ\text{C}$	

Note 1. Minimum VIN voltage is defined by output adds a dropout voltage.

Note 2. Current limit is measured at constant junction temperature by using pulsed testing with a low ON time.

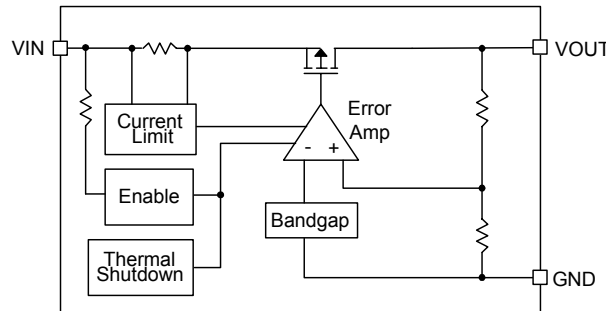
Note 3. Regulation is measured at constant junction temperature by using pulsed testing with a low ON time.



PIN DESCRIPTIONS

PIN SYMBOL	PIN DESCRIPTION
VIN	Input voltage
GND	Ground
VOUT	Output Voltage

BLOCK DIAGRAM



FUNCTION PIN DESCRIPTION

A minimum of 2.2µF capacitor must be connected from VOUT to ground to insure stability. Typically a large storage capacitor is connected from VIN to ground to ensure that the input voltage does not sag below the minimum dropout voltage during the load transient response. This pin must always be dropout voltage higher than VOUT in order for the device to regulate properly.

APPLICATION INFORMATION

Like any low-dropout regulator, the APE8970/A requires input and output decoupling capacitors. The device is specifically designed for portable applications requiring minimum board space and smallest components. These capacitors must be correctly selected for good performance (see Capacitor Characteristics Section). Please note that linear regulators with a low dropout voltage have high internal loop gains which require care in guarding against oscillation caused by insufficient decoupling capacitance.

Capacitor Selection

Normally, use a 2.2µF capacitor on the input and a 2.2µF capacitor on the output of the APE8970/A. Larger input capacitor values and lower ESR (X5R, X7R) provide better supply-noise rejection and transient response. A higher- value output capacitor (4.7µF) may be necessary if large, fast transients are anticipated and the device is located several inches from the power source.

Input-Output (Dropout) Voltage

A regulator's minimum input-to-output voltage differential (dropout voltage) determines the lowest usable supply voltage. In battery-powered systems, this determines the useful end-of-life battery voltage. Because the device uses a PMOS, its dropout voltage is a function of drain-to source on-resistance, R_{DS (ON)}, multiplied by the load current:

$$V_{\text{DROPOUT}} = V_{\text{IN}} - V_{\text{OUT}} = R_{\text{DS (ON)}} \times I_{\text{OUT}}$$



Current Limit and Short-Circuit Protection

The APE8970/A used a current sense-resistor to monitor the output current. A portion of the PMOS output transistor's current is mirrored to a resistor such that the voltage across this resistor is proportional to the output current. Once the output current exceeds limit threshold, APE8970/A would be protected with a limited output current. Further more, when the output is short to ground, the output current would be folded-back to a less limit.

Thermal Considerations

The APE8970/A series can deliver a current of up to 1.2A over the full operating junction temperature range. However, the maximum output current must be dated at higher ambient temperature to ensure the junction temperature does not exceed 125°C. With all possible conditions, the junction temperature must be within the range specified under operating conditions. Power dissipation can be calculated based on the output current and the voltage drop across regulator.

$$P_D = (V_{IN} - V_{OUT}) I_{OUT}$$

The final operating junction temperature for any set of conditions can be estimated by the following thermal equation:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / R_{thJA}$$

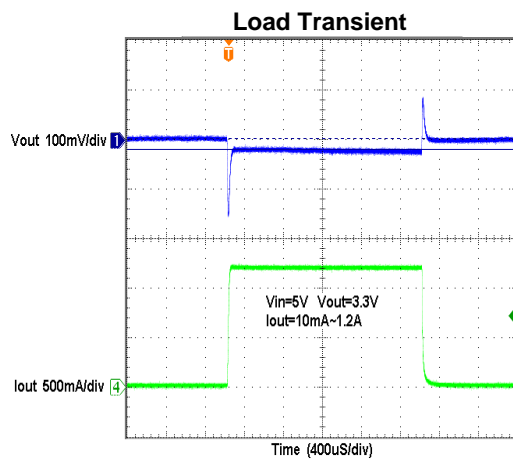
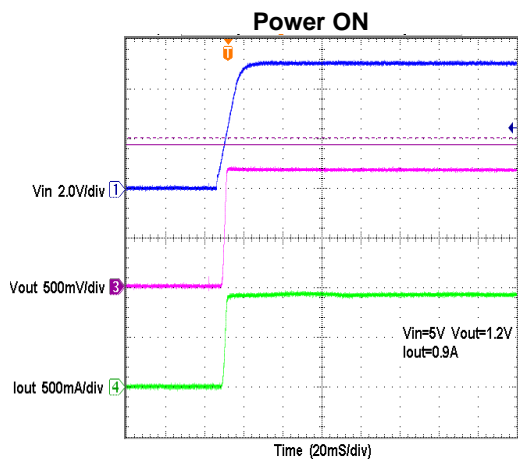
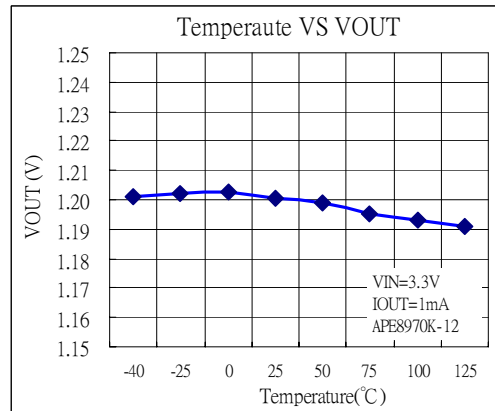
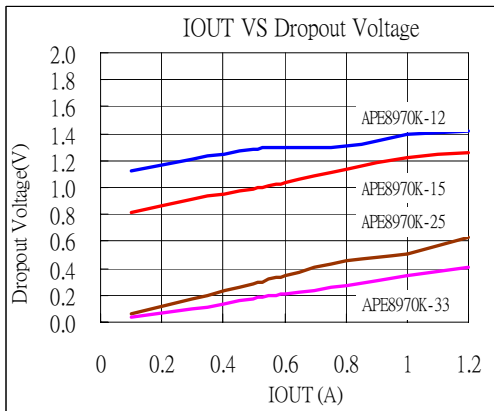
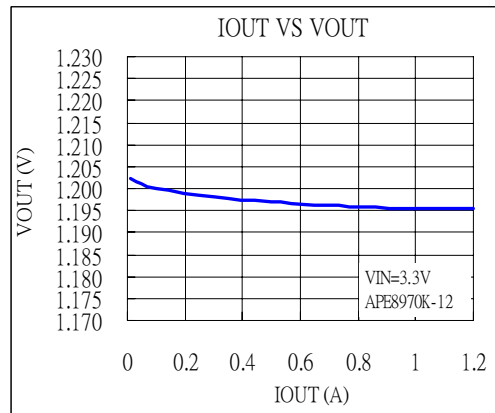
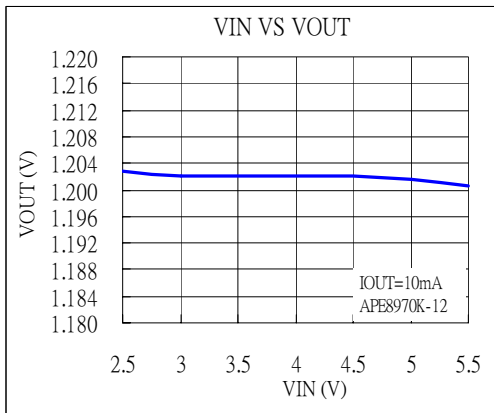
Where $T_{J(MAX)}$ is the maximum junction temperature of the die (125° C) and T_A is the maximum ambient temperature. The junction to ambient thermal resistance (θ_{JA}) for SOT-223 package at recommended minimum footprint is 75°C/W (please refer Maximum rating table).

PCB Layout

An input capacitance of $\approx 2.2\mu F$ is required between the APE8970/A input pin and ground (the amount of the capacitance may be increased without limit), this capacitor must be located a distance of not more than 1cm from the input and return to a clean analog ground. Input capacitor can filter out the input voltage spike caused by the surge current due to the inductive effect of the package pin and the printed circuit board's routing wire. Otherwise, the actual voltage at the VIN pin may exceed the absolute maximum rating. The output capacitor also must be located a distance of not more than 1cm from output to a clean analog ground. Because it can filter out the output spike caused by the surge current due to the inductive effect of the package pin and the printed circuit board's routing wire.



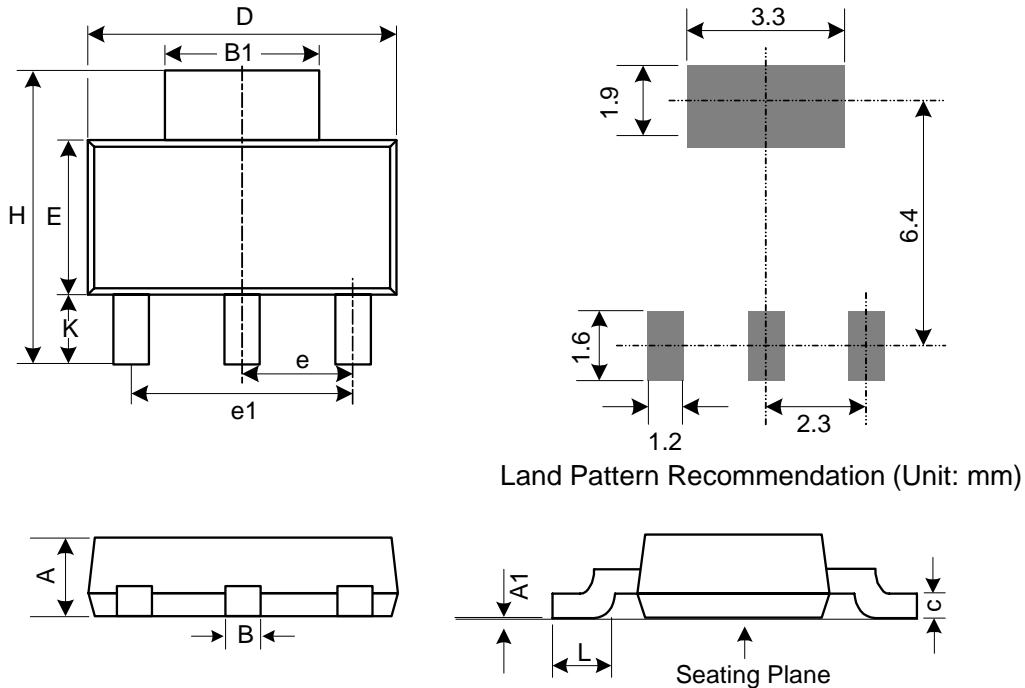
TYPICAL PERFORMANCE CHARACTERISTICS





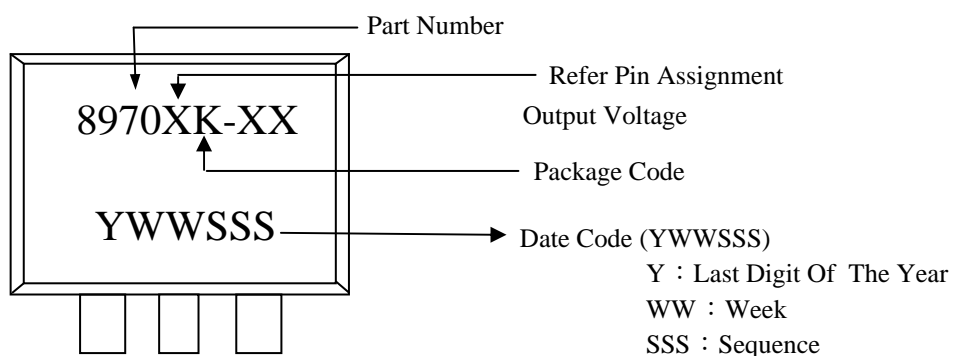
PACKAGE OUTLINE

(1) SOT-223



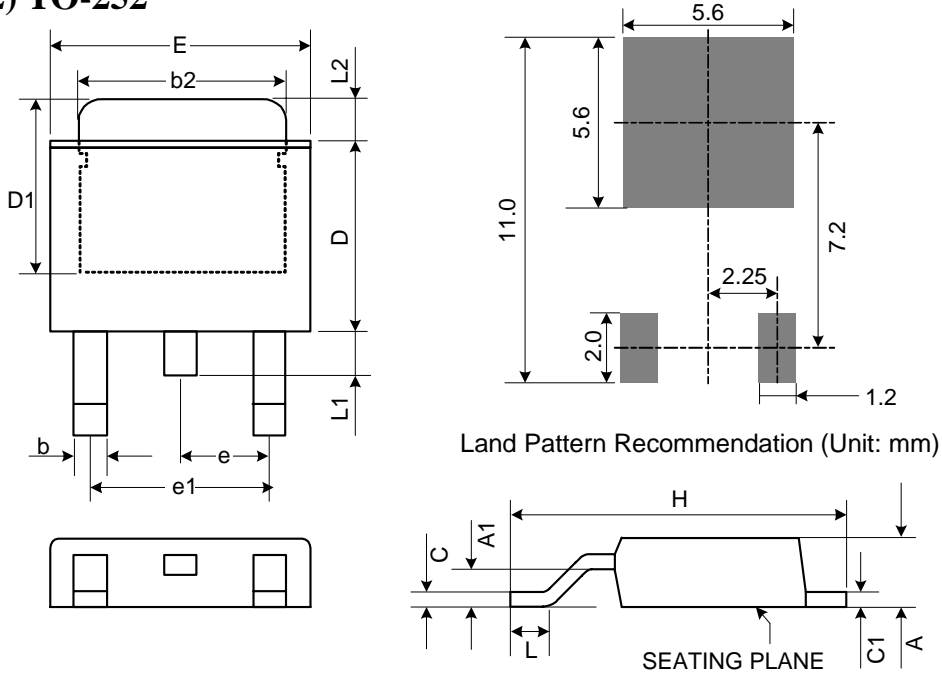
Symbol	Dimensions In Millimeters			Dimensions In Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	1.50	1.65	1.80	0.059	0.065	0.071
A1	0.02	0.05	0.08	0.001	0.002	0.003
B	0.60	0.70	0.80	0.024	0.028	0.031
B1	2.90	-	3.15	0.114	-	0.124
C	0.28	0.30	0.32	0.011	0.012	0.013
D	6.30	6.50	6.70	0.248	0.256	0.264
E	3.30	3.50	3.70	0.130	0.138	0.146
H	6.70	7.00	7.30	0.264	0.276	0.287
L	0.91	1.00	1.10	0.036	0.039	0.043
K	1.50	1.75	2.00	0.059	0.069	0.079
e	2.3 Basic			0.091 Basic		
e1	4.6 Basic			0.181 Basic		

Marking Information



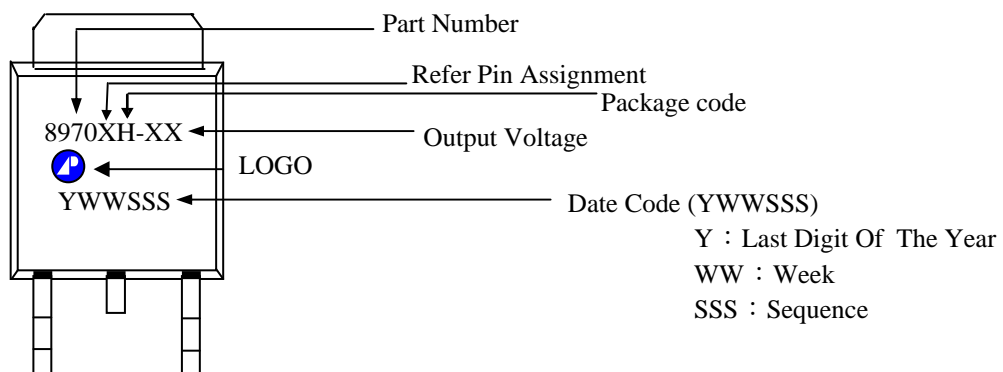


(2) TO-252



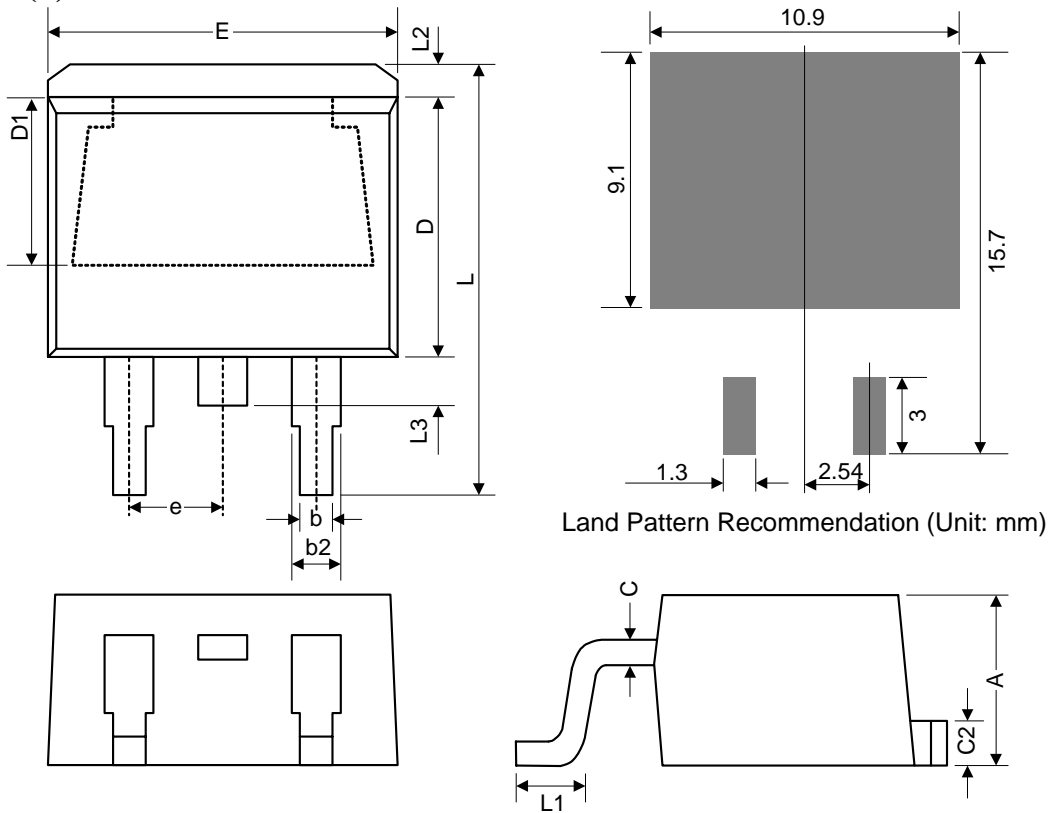
Symbo l	Dimensions In Millimeters			Dimensions In Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	2.18	2.29	2.40	0.086	0.090	0.094
A1	0.89	-	1.14	0.035	-	0.045
b	0.61 TYP.			0.024 TYP.		
b2	5.20	5.35	5.50	0.205	0.211	0.217
C	0.45	0.52	0.58	0.018	0.020	0.023
C1	0.45	0.52	0.58	0.018	0.020	0.023
D	5.40	5.57	6.20	0.213	0.219	0.244
D1	4.57	4.77	4.97	0.180	0.188	0.196
E	6.35	6.58	6.80	0.250	0.259	0.268
e	2.28 BSC.			0.090 BSC.		
e1	4.57 BSC.			0.180 BSC.		
H	9.00	9.70	10.40	0.354	0.382	0.409
L	0.51	-	-	0.020	-	-
L1	0.64	0.83	1.02	0.025	0.033	0.040
L2	0.88	-	1.27	0.035	-	0.050

Marking Information





(3) TO-263



Symbo l	Dimensions In Millimeters			Dimensions In Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	4.06	4.45	4.83	0.160	0.175	0.190
b	0.51	0.75	0.99	0.020	0.030	0.039
b2	1.14	1.27	1.40	0.045	0.050	0.055
C	0.38 TYP.			0.015 TYP.		
C2	1.14	1.27	1.40	0.045	0.050	0.055
D	8.65	9.15	9.65	0.341	0.360	0.380
D1	5.10	5.60	6.10	0.200	0.220	0.240
E	9.65	9.97	10.29	0.380	0.393	0.405
e	2.54 BSC.			0.100 BSC.		
L	14.61	15.24	15.88	0.575	0.600	0.625
L1	2.28	2.54	2.80	0.090	0.100	0.110
L2	-	1.30	2.92	-	0.051	0.115
L3	1.27	1.52	1.78	0.050	0.060	0.070

Marking Information

